



DC to 5000 MHz, CASCADABLE SiGe HBT MMIC AMPLIFIER

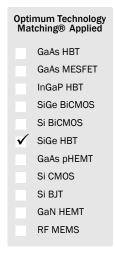
Package: SOT-86

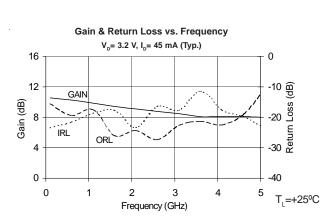




Product Description

The SGA4186Z is a high performance SiGe HBT MMIC Amplifier. A Darlington configuration featuring one-micron emitters provides high F_T and excellent thermal performance. The heterojunction increases breakdown voltage and minimizes leakage current between junctions. Cancellation of emitter junction non-linearities results in higher suppression of intermodulation products. Only two DC-blocking capacitors, a bias resistor, and an optional RF choke are required for operation.





Features

- Broadband Operation: DC to 5000 MHz
- Cascadable 50Ω
- Operates from Single Supply
- Low Thermal Resistance Package

Applications

- PA Driver Amplifier
- Cellular, PCS, GSM, UMTS
- IF Amplifier
- Wireless Data, Satellite

Parameter	Specification			Unit	Condition	
Parameter	Min.	Тур.	Max.	UIIIL	Condition	
Small Signal Gain	9.0	10.0	11.0	dB	850MHz	
		9.2		dB	1950MHz	
		8.9		dB	2400MHz	
Output Power at 1dB Compression		14.6		dBm	850MHz	
		12.4		dBm	1950MHz	
Output Third Intercept Point		28.3		dBm	850MHz	
		25.5		dBm	1950MHz	
Bandwidth Determined by Return Loss		5000		MHz	>10dB	
Input Return Loss		20.3		dB	1950MHz	
Output Return Loss		24.4		dB	1950MHz	
Noise Figure		5.0		dB	1950MHz	
Device Operating Voltage	2.9	3.2	3.5	V		
Device Operating Current	41	45	49	mA		
Thermal Resistance (Junction - Lead)		97		°C/W		

Test Conditions: $V_S = 8V$, $I_D = 45$ mA Typ., OIP₃ Tone Spacing = 1MHz, P_{OUT} per tone = -5 dBm, $R_{BIAS} = 110 \Omega$, $T_L = 25$ °C, $Z_S = Z_L = 50 \Omega$



Absolute Maximum Ratings

Parameter	Rating	Unit
Max Device Current (I _D)	90	mA
Max Device Voltage (V _D)	5	V
Max RF Input Power	+18	dBm
Max Junction Temp (T _J)	+150	°C
Operating Temp Range (T _L)	-40 to +85	°C
Max Storage Temp	+150	°C

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one. Bias Conditions should also satisfy the following expression: $I_D V_D < (T_J - T_L) / \, R_{TH}, \, j \text{-} I$



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

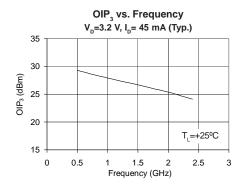
RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

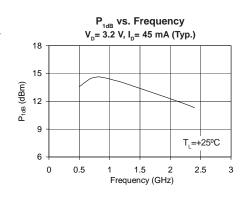
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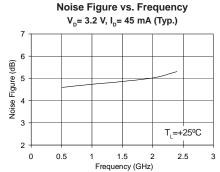
Typical Performance at Key Operating Frequencies

Parameter	Unit	100	500	850	1950	2400	3500
		MHz	MHz	MHz	MHz	MHz	MHz
Small Signal Gain	dB	10.5	10.4	10.0	9.2	8.9	8.1
Output Third Order Intercept Point	dBm		29.3	28.3	25.5	24.1	
Output Power at 1dB Compression	dBm		13.6	14.6	12.4	11.3	
Input Return Loss	dB	23.6	25.6	16.2	20.3	22.7	11.7
Output Return Loss	dB	15.6	20.4	14.8	24.4	24.1	21.7
Reverse Isolation	dB	15.8	16.0	16.5	17.9	18.2	19.2
Noise Figure	dB		4.6	4.7	5.0	5.3	

Test Conditions: V_S = 8V, I_D = 45 mA Typ., OIP₃ Tone Spacing = 1MHz, P_{OUT} per tone = -5dBm, R_{BIAS} = 110 Ω , T_L = 25 °C, Z_S = Z_L = 50 Ω

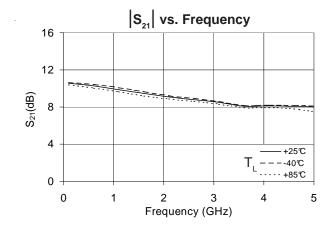


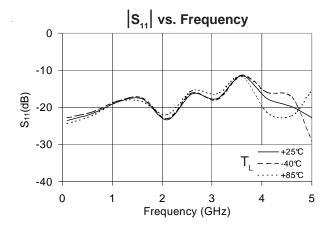


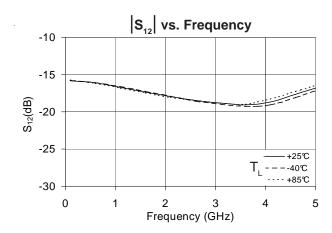


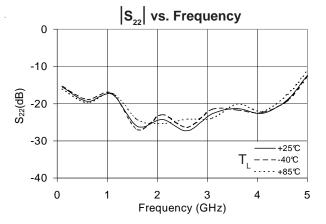


Typical RF Performance Over Temperature (Bias: $V_D = 3.2 \text{ V}, \ I_D = 45 \text{ mA}$ (Typ.))





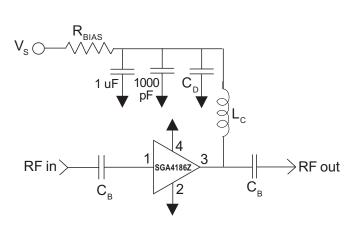






Pin	Function	Description
1	RF IN	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
2, 4	GND	Connection to ground. For optimum RF performance use via holes as close to ground leads as possible to reduce lead inductance.
3	RF OUT/BIAS	RF output and bias pin. DC voltage is present on this pin, therefore a DC clocking capacitor is necessary for proper operation.

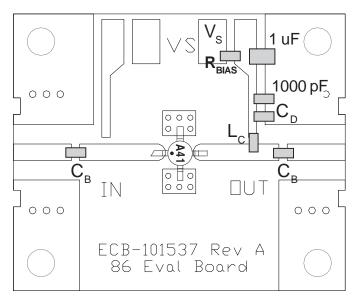
Application Schematic



Reference	Frequency (Mhz)					
Designator	500	850	1950	2400	3500	
C _B	220 pF	100 pF	68 pF	56 pF	39 pF	
C _D	100 pF	68 pF	22 pF	22 pF	15 pF	
L _c	68 nH	33 nH	22 nH	18 nH	15 nH	

Recommended Bias Resistor Values for $I_D=45$ mA $R_{BIAS}=(V_S-V_D)/I_D$					
Supply Voltage(V _S)	6 V	8 V	10 V	12 V	
R _{BIAS}	62 Ω	110 Ω	150Ω	200 Ω	
Note: R _{BIAS} provides DC bias stability over temperature.					

Evaluation Board Layout

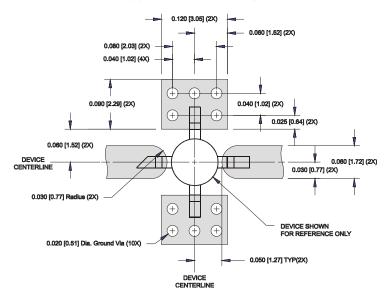


Mounting Instructions

- 1. Use a large ground pad area under device pins 2 and 4 with many plated through-holes as shown.
- We recommend 1 or 2 ounce copper. Measurements for this data sheet were made on a 31 mil thick FR-4 board with 1 ounce copper on both sides.

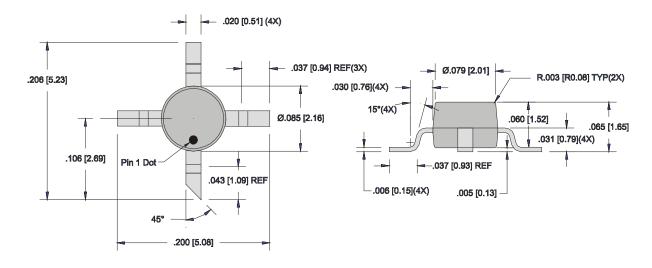


Suggested Pad Layout



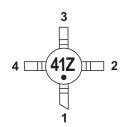
Package Drawing

Dimensions in inches (millimeters)
Refer to drawing posted at www.rfmd.com for tolerances.





Part Identification



Ordering Information

Ordering Code	Description
SGA4186Z	13" Reel with 3000 pieces
SGA4186ZSQ	Sample bag with 25 pieces
SGA4186ZSR	7" Reel with 100 pieces
SGA4186ZPCK1	850MHz, 8V Operation PCBA with 5-piece sample bag